

Sir:

Transmitted herewith for filing is the Patent Application of:

Inventor: SHYUE FONG QUEK, TING CHEONG ANG, YEE CHONG WONG AND SANG YEE LOONG

J1050:U.S. ~~DOUBLE~~ LAYERED LOW DIELECTRIC CONSTANT DIELECTRIC DUAL DAMASCEME METHOD



04/30/01

Enclosed are:

Jc973 U.S. PTO
09/045480
04/30/01

- ☒ 10 sheets of drawing(s) - formal.
- ☒ An assignment of the invention to **Chartered Semiconductor Manufacturing Ltd.**
- ☐ An associate power of attorney ☐ Applicant claims small entity status
- ☐ Request & Certification under 35 USC 122(b)(2)(b)(i)

The filing fee has been calculated as shown below:

	(Col. 1)	(Col. 2)	OTHER THAN A SMALL ENTITY	
FOR:	NO. FILED	NO. EXTRA	RATE	FEE
BASIC FEE				\$ 710.
TOTAL CLAIMS	30 -20=	10	x 18 =	\$ 180.
INDEP CLAIMS	6 -3=	3	x 80 =	\$ 240.
MULTIPLE DEPENDENT CLAIM PRESENTED			+ 260 =	
			SUB TOTAL	\$ 1,130.
			ASSIGNMENT	\$40.
			TOTAL	\$ 1,170.

- ☒ Please charge my Deposit Account No. 19-0033 in the amount of \$ 1,170. A duplicate copy of this sheet is enclosed.
- ☒ The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No. 19-0033. A duplicate copy of this sheet is enclosed.
- ☒ Any additional filing fees required under 37 CFR \$1.16.
- ☒ Any patent application processing fees under 37 CFR \$1.17.

Respectfully submitted,

STEPHEN B. ACKERMAN, REG. NO. 37,761